



- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

Product Summary

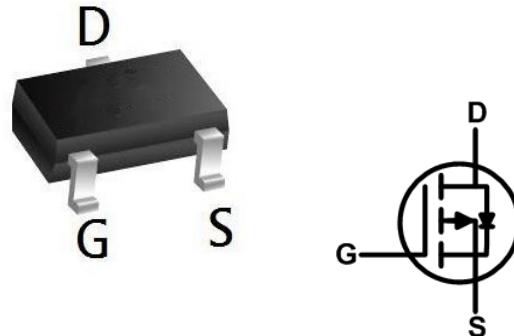
BVDSS	RDS(ON)	ID
-40V	45mΩ	-5 A

Description

The XR5P04L is the high cell density trenched P-ch MOSFETs, which provides excellent RDS(ON) and efficiency for most of the small power switching and load switch applications.

The XR5P04L meet the RoHS and Green Product requirement with full function reliability approved.

SOT 23 -3L Pin Configurations



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	-40	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_A = 25^\circ C$	Continuous Drain Current	-5	A
$I_D @ T_A = 70^\circ C$	Continuous Drain Current	-3.6	A
I_{DM}	Pulsed Drain Current ²	-22	A
$P_D @ T_A = 25^\circ C$	Total Power Dissipation ³	2.0	W
$P_D @ T_A = 70^\circ C$	Total Power Dissipation ³	1.5	W
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient ¹	---	65	°C/W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient ¹ ($t \leq 10s$)	---	48	°C/W

P-Ch 40V Fast Switching MOSFETs

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
Off Characteristics						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D = -250\mu\text{A}$	-40	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}= -40\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	-1	μA
I_{GSS}	Gate to Body Leakage Current	$V_{\text{DS}}=0\text{V}$, $V_{\text{GS}}= \pm 20\text{V}$	-	-	± 100	nA
On Characteristics						
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_D = -250\mu\text{A}$	-1.0	-1.6	-2.5	V
$R_{\text{DS}(\text{on})}$ Note2	Static Drain-Source on-Resistance	$V_{\text{GS}}= -10\text{V}$, $I_D = -5\text{A}$	-	45	54	$\text{m}\Omega$
		$V_{\text{GS}}= -4.5\text{V}$, $I_D = -4\text{A}$	-	60	85	
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}= -20\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1.0\text{MHz}$	-	869	-	pF
C_{oss}	Output Capacitance		-	94	-	pF
C_{rss}	Reverse Transfer Capacitance		-	69	-	pF
Q_g	Total Gate Charge	$V_{\text{DS}}= -20\text{V}$, $I_D = -4\text{A}$, $V_{\text{GS}}= -10\text{V}$	-	17.3	-	nC
Q_{gs}	Gate-Source Charge		-	3.2	-	nC
Q_{gd}	Gate-Drain("Miller") Charge		-	4.3	-	nC
Switching Characteristics						
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{DS}}= -20\text{V}$, $I_D = -4\text{A}$, $V_{\text{GS}}= -10\text{V}$, $R_{\text{GEN}}=3\Omega$	-	10.3	-	ns
t_r	Turn-on Rise Time		-	4.3	-	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time		-	39	-	ns
t_f	Turn-off Fall Time		-	46.5	-	ns
Drain-Source Diode Characteristics and Maximum Ratings						
I_s	Maximum Continuous Drain to Source Diode Forward Current	-	-	-5.0	A	
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current	-	-	-22	A	
V_{SD}	Drain to Source Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$, $I_s = -5.5\text{A}$	-	-0.8	-1.2	V
trr	Reverse Recovery Time	$V_{\text{GS}}=0\text{V}$, $I_s = -5.5\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$	-	17	-	ns
Q_{rr}	Reverse Recovery Charge		-	11.5	-	nC

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%

Typical Performance Characteristics

Figure 1: Output Characteristics

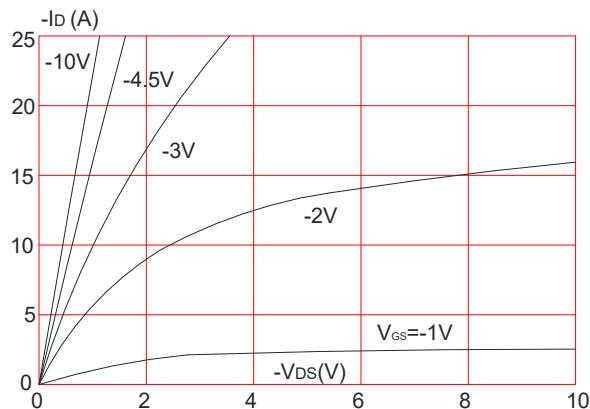


Figure 3: On-resistance vs. Drain Current

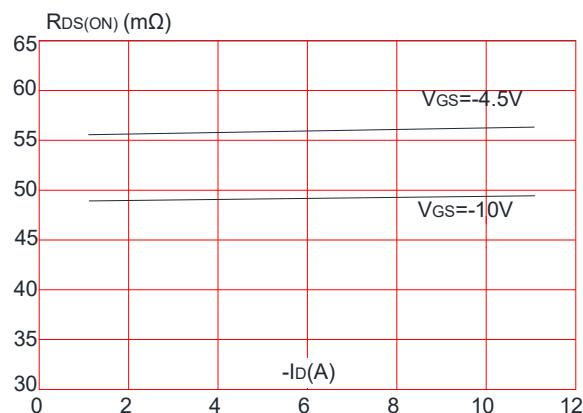


Figure 5: Gate Charge Characteristics

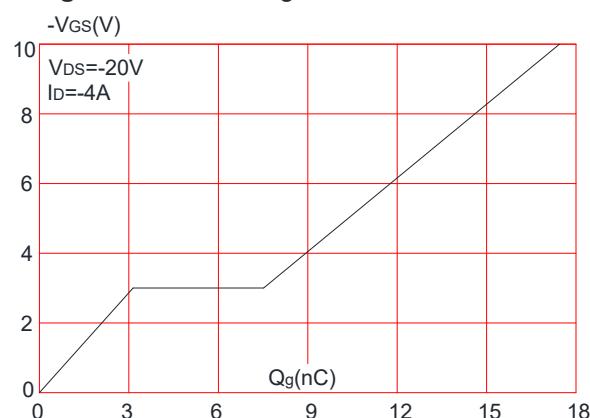


Figure 2: Typical Transfer Characteristics

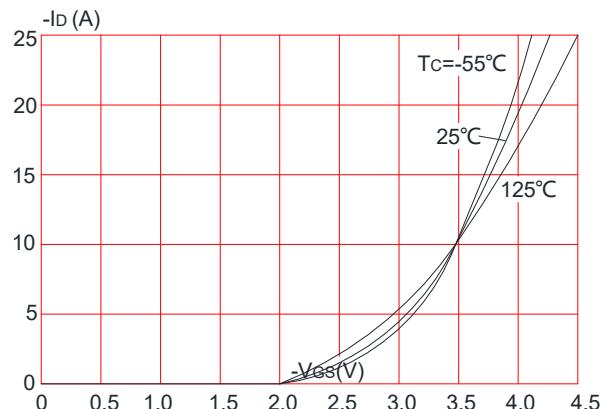


Figure 4: Body Diode Characteristics

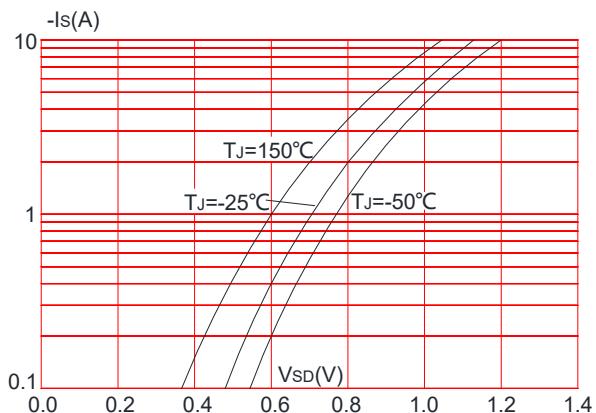
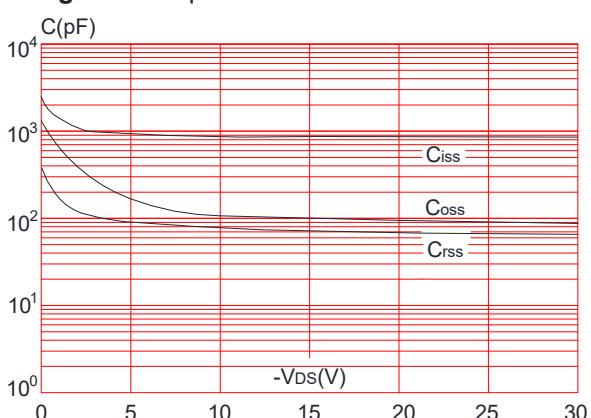


Figure 6: Capacitance Characteristics



P-Ch 40V Fast Switching MOSFETs

Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

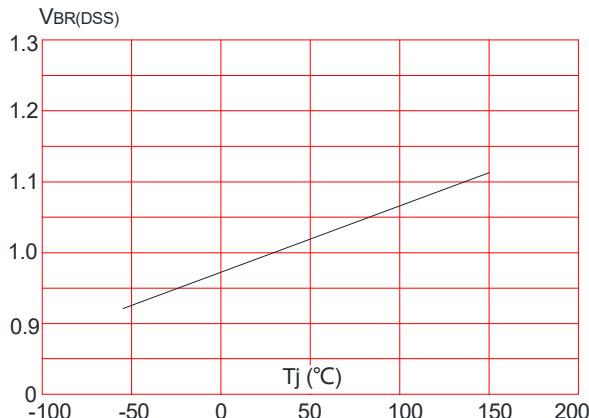


Figure 9: Maximum Safe Operating Area

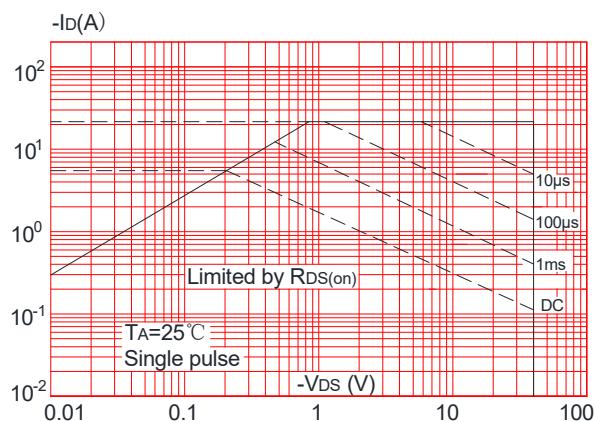


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

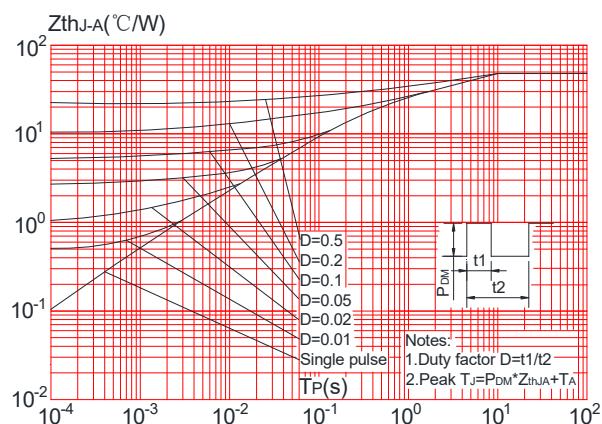


Figure 8: Normalized on Resistance vs. Junction Temperature

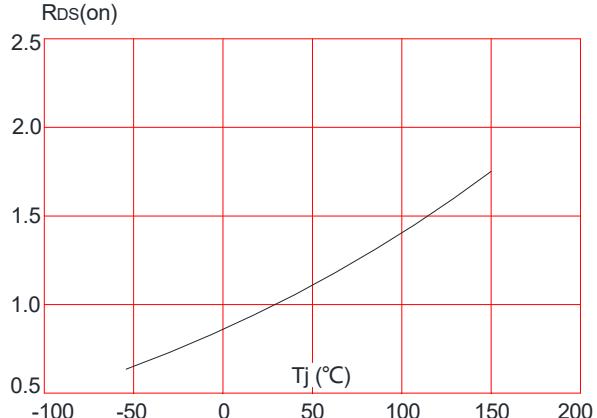
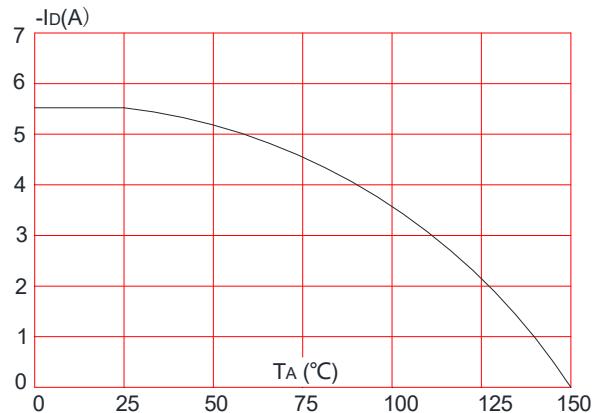
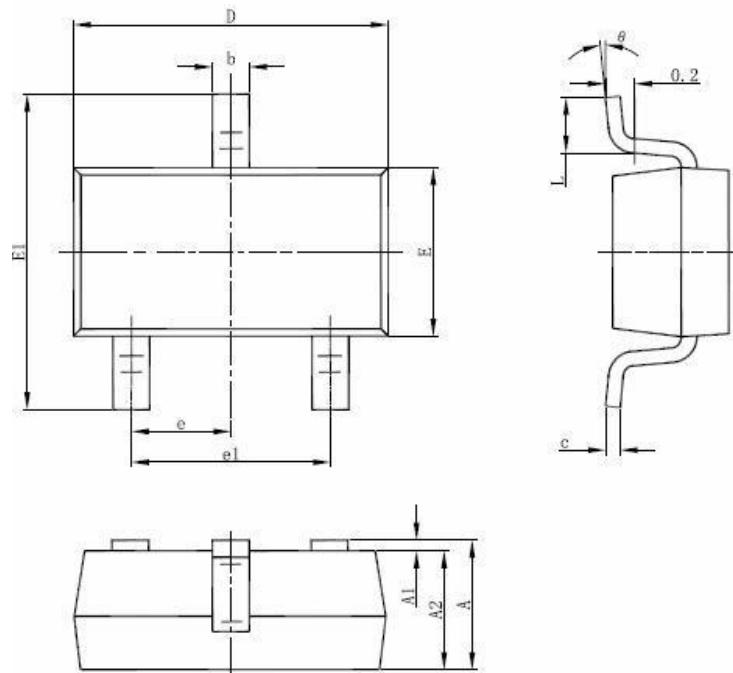


Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature



Package Mechanical Data-SOT-23-3L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°